

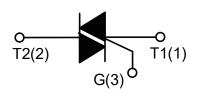
### **DESCRIPTION:**

With high ability to withstand the shock loading of large current, T405-800B series triacs provide high dv/dt rate with strong resistance to electromagnetic interface. With high commutation performances, 3 quadrants products especially recommended for use on inductive load.



#### **MAIN FEATURES**

| Symbol                             | Value   | Unit |
|------------------------------------|---------|------|
| V <sub>DRM</sub> /V <sub>RRM</sub> | 600/800 | V    |
| I <sub>T(RMS)</sub>                | 4       | A    |



### **ABSOLUTE MAXIMUM RATINGS**

| Pa  | rameter                           | Symbol              | Value     | Unit             |
|---|-----------------------------------|---------------------|-----------|------------------|
| Storage junction temperature range                                  |                                   | T <sub>stg</sub>    | -40 - 150 | $^{\circ}$ C     |
| Operating junction temperature range                                |                                   | Tj                  | -40 - 125 | $^{\circ}$ C     |
| Repetitive peak off-state voltage (T <sub>j</sub> =25℃)             |                                   | VDRM                | 600/800   | V                |
| Repetitive peak reverse voltage (Tj=25℃)                            |                                   | V <sub>RRM</sub>    | 600/800   | V                |
| RMS on-state current  | TO-252<br>(T <sub>C</sub> =100°C) | I <sub>T(RMS)</sub> | 4         | А                |
| Non repetitive surge peak on-state current (full cycle, F=50Hz)     |                                   | I <sub>TSM</sub>    | 40        | Α                |
| I <sup>2</sup> t value for fusing (tp=10ms)                         |                                   | l <sup>2</sup> t    | 8         | A <sup>2</sup> s |
| Critical rate of rise of on-state current $(I_G = 2 \times I_{GT})$ |                                   | dl/dt               | 50        | A/µs             |
| Peak gate current   |                                   | I <sub>GM</sub>     | 4         | Α                |
| Average gate power dissipation                                      |                                   | P <sub>G(AV)</sub>  | 1         | W                |
| Peak gate power   |                                   | Рдм                 | 5         | W                |



# **ELECTRICAL CHARACTERISTICS** ( $T_j$ =25 $^{\circ}$ C unless otherwise specified)

| Symbol           | Test Condition (   | Quadrant    |       | Value |     |     |      | Unit |
|------------------|--|-------------|-------|-------|-----|-----|------|------|
|                  | rest Condition   |             |       | TW    | sw  | CW  | BW   | Uill |
| lgт              | V -40V D -220  | I - II -III | MAX   | 5     | 10  | 35  | 50   | mA   |
| V <sub>G</sub> T | V <sub>D</sub> =12V R <sub>L</sub> =33Ω                            | I - II -III | MAX   | 1.5   |     |     |      | V    |
| V <sub>GD</sub>  | $V_D = V_{DRM} T_j = 125^{\circ}C$<br>$R_L = 3.3 K\Omega$          | I - II -III | MIN   |       | C   | ).2 |      | V    |
| I.               | 1 -4 01  | I -III      | MAX   | 10    | 20  | 50  | 70   | mA   |
| l IL             | I <sub>G</sub> =1.2I <sub>GT</sub>                                 | II          | IVIAA | 15    | 35  | 60  | 80   | IIIA |
| Ін               | I <sub>T</sub> =100mA  |             | MAX   | 10    | 15  | 35  | 60   | mA   |
| dV/dt            | V <sub>D</sub> =2/3V <sub>DRM</sub> Gate Open T <sub>j</sub> =125℃ |             | MIN   | 50    | 100 | 400 | 1000 | V/µs |

## **STATIC CHARACTERISTICS**

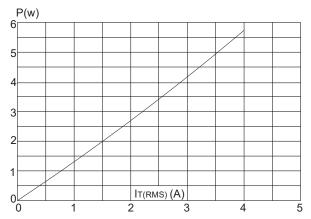
| Symbol           | Parameter   |                     | Value(MAX) | Unit |
|------------------|---|---------------------|------------|------|
| V <sub>TM</sub>  | I <sub>тм</sub> =5.5A tp=380µs                                    | T <sub>j</sub> =25℃ | 1.5        | V    |
| IDRM             | V <sub>D</sub> =V <sub>DRM</sub> V <sub>R</sub> =V <sub>RRM</sub> | T <sub>j</sub> =25℃ | 10         | μΑ   |
| I <sub>RRM</sub> |   | Tj=125℃             | 0.75       | mA   |

## **THERMAL RESISTANCES**

| Symbol               | Parameter            |        | Value | Unit |
|----------------------|----------------------|--------|-------|------|
| R <sub>th(j-c)</sub> | junction to case(AC) | TO-252 | 2.8   | °C/W |
| R <sub>th(j-a)</sub> | junction to ambient  | 10-252 | 70    | C/VV |



**FIG.1:** Maximum power dissipation versus RMS on-state current



**FIG.3:** Surge peak on-state current versus number of cycles

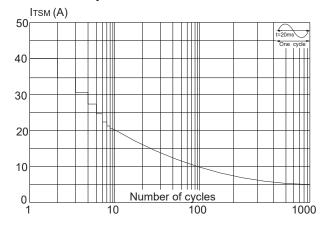
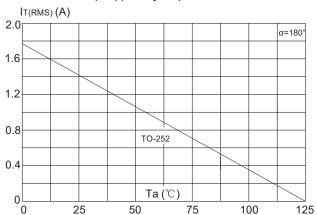
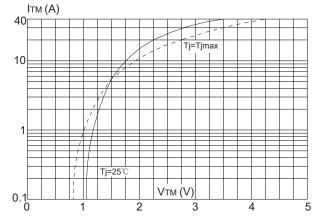


FIG.2: RMS on-state current versus ambient temperature (printed circuit board FR4, copper thickness:35µm)(full cycle)

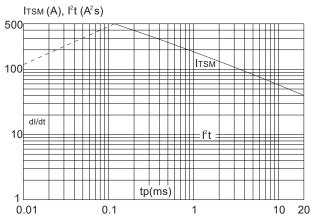


**FIG.4:** On-state characteristics (maximum values)

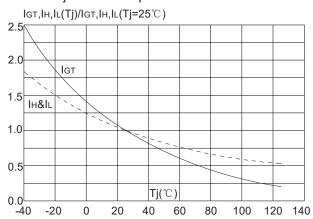




**FIG.5:** Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp<20ms and corresponding value of I<sup>2</sup>t (dI/dt < 50A/µs)



**FIG.6:** Relative variations of gate trigger current, holding current and latching current versus junction temperature



### **SOLDERING PARAMETERS**

| Reflow Condition   |   | Pb-Free assembly (see figure at right) |  |
|--|---|--|--|
|  | -Temperature Min (T <sub>s(min)</sub> )     | +150°C                                 |  |
| Pre<br>Heat  | -Temperature Max (T <sub>s(max)</sub> )     | <b>+200</b> ℃                          |  |
|  | -Time (Min to Max)<br>(ts)                  | 60-180 secs.                           |  |
| Average ramp up rate<br>(Liquidus Temp (T <sub>L</sub> )to peak) |   | 3°C/sec. Max                           |  |
| T <sub>s(max)</sub> to T <sub>L</sub> - Ramp-up Rate             |   | 3℃/sec. Max                            |  |
| Reflow   | -Temperature(T <sub>L</sub> )<br>(Liquidus) | +217°C                                 |  |
|  | -Temperature(t <sub>L</sub> )               | 60-150 secs.                           |  |
| Peak Temp (T <sub>p</sub> )                                      |   | +260(+0/-5)°C                          |  |
| Time within 5°C of actual Peak Temp (t <sub>p</sub> )            |   | 20-40secs.                             |  |
| Ramp-down Rate   |   | 6℃/sec. Max                            |  |
| Time 25℃ to Peak Temp (T <sub>P</sub> )                          |   | 8 min. Max                             |  |
| Do not exceed  |   | +260℃                                  |  |

